

GENERAL DESCRIPTION

The PT4121 is a high efficiency step-down controller. It is designed to operate in continuous conduction mode and drive single or multiple series connected LED efficiently from a voltage source higher than the total LED chain voltage. It operates with a wide input voltage from 6V to 60V and provides an externally adjustable output current.

The PT4121 includes a high-side output current sense circuit, which uses an external resistor to set the nominal average output current, and a dedicated DIM input accepts either a DC voltage or PWM dimming.

The PT4121 is available in SOT23-6 or SOP8 package.


FEATURES

- Simple low parts count
- Wide input voltage range: 6V to 60V
- High efficiency (up to 97%)
- Single pin on/off and brightness control using DC Voltage or PWM
- Up to 1MHz switching frequency
- Adjustable Constant LED Current
- Typical 3% output current accuracy
- High-Side Current Sense
- Hysteretic Control: No need compensation
- Inherent R_{CS} open protection
- Inherent open-circuit LED protection
- Inherent short-circuit LED protection
- Thermal shutdown

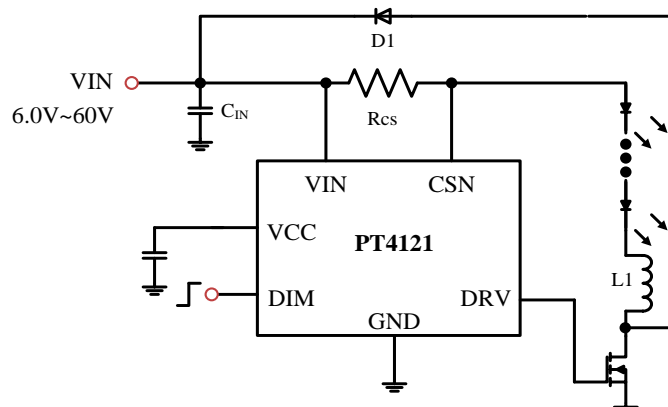
APPLICATIONS

- Low voltage halogen replacement LEDs
- Automotive/Decorative lighting
- Low voltage industrial lighting
- LED back-up lighting
- Signs/Emergency lighting
- SELV lighting
- LCD TV backlighting

ORDERING INFORMATION

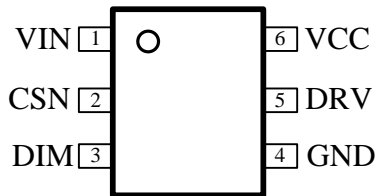
PACKAGE	TEMPERATURE RANGE	ORDERING PART NUMBER	TRANSPORT MEDIA	MARKING
SOT23-6	-40 °C to 85 °C	PT4121E23F	Tape and Reel 3000 units	4121
SOP8	-40 °C to 85 °C	PT4121ESOH	Tape and Reel 2500 units	 PT4121 xxxxxX

TYPICAL APPLICATION CIRCUIT



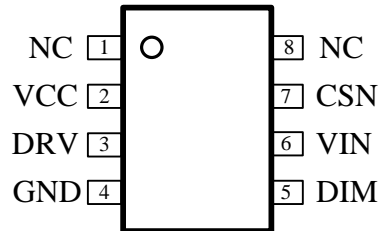
PIN ASSIGNMENT

TOP VIEW



SOT23-6

TOP VIEW



SOP8

PIN DESCRIPTIONS

SOT23-6 PIN No.	PIN NAMES	DESCRIPTION
1	VIN	Input Supply Pin. Connect a decoupling capacitor from VIN pin to GND
2	CSN	LED Current Sense Input. Connect a current-sense resistor that programs LED average current to the VIN pin.
3	DIM	Logic level dimming input. Drive DIM low to turn off the current regulator. Drive DIM high to enable the current regulator.
4	GND	Signal and power ground. Connect directly to ground plane.
5	DRV	Gate-Driver Output. Connect this pin to the gate of the external MOSFET.
6	VCC	Internal Regulator Output. Connect a 1 μ F decoupling cap from this pin to ground
SOP8 PIN No.	PIN NAMES	DESCRIPTION
1	NC	None connected
2	VCC	Internal Regulator Output. Connect a 1 μ F decoupling cap from this pin to ground
3	DRV	Gate-Driver Output. Connect this pin to the gate of the external MOSFET.
4	GND	Signal and power ground. Connect directly to ground plane.
5	DIM	Logic level dimming input. Drive DIM low to turn off the current regulator. Drive DIM high to enable the current regulator.
6	VIN	Input Supply Pin. Connect a decoupling capacitor from VIN pin to GND
7	CSN	LED Current Sense Input. Connect a current-sense resistor that programs LED average current to the VIN pin.
8	NC	None connected

ABSOLUTE MAXIMUM RATINGS ^(note1)

SYMBOL	ITEMS	VALUE	UNIT
V _{IN}	Supply Voltage	-0.3~65	V
CSN	Current sense input (Respect to VIN)	+0.3~(-6.0)	V
DIM	Logic level dimming input	-0.3~6	V
P _{DMAX}	Max Power Dissipation(TA=25°C) ^(Note 2)	0.56	W
P _{TR}	SOT23-6Thermal Resistance(TA=25°C)	220	°C /W
P _{TR}	SOP8 Thermal Resistance(TA=25°C)	184	°C /W
T _J	Junction Temperature	150	°C
T _{OPT}	Operating Temperature Range	-40~125	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
	ESD Susceptibility ^(Note 3)	2	kV

RECOMMENDED OPERATING RANGE

SYMBOL	ITEMS	VALUE	UNIT
V _{IN}	V _{IN} Supply Voltage	6 ~ 60	V
T _{OPT}	Operating Temperature	-40 to +85	°C

Note 1: Exceeding these Absolute Maximum Ratings may damage the device. Recommended Operating Range indicates conditions for which the device is functional. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Range. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX}, θ_{JA}, and the ambient temperature T_A. The maximum allowable power dissipation is P_{DMAX} = (T_{JMAX} - T_A) / θ_{JA} or the number given in Absolute Maximum Ratings, whichever is lower.

Note 3: Human body model, 100pF discharged through a 1.5kΩ resistor.

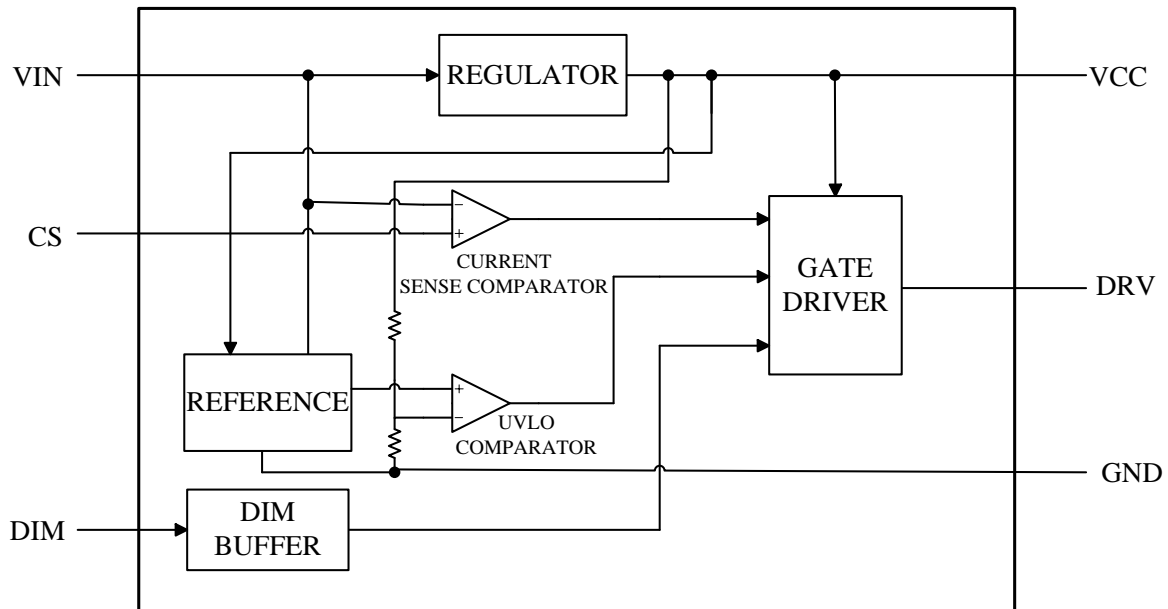
ELECTRICAL CHARACTERISTICS (Note 4, 5)

The following specifications apply for $V_{IN}=24V$, $T_A=25^{\circ}C$, unless specified otherwise.

SYMBOL	ITEMS	CONDITIONS	Min.	Typ.	Max.	UNIT
V_{IN}	Input Voltage		6		60	V
VCC	Internal Regulated Voltage		4.5	5.0	5.5	V
V_{UVLO}	Under voltage lock out	VCC rising		4.8		V
V_{UVLO_HYS}	UVLO hysteresis	VCC falling		0.3		V
F_{SW}	Max. Switching Frequency			1		MHz
Current Sense						
V_{CSN}	Current sense threshold voltage	$V_{IN}-V_{CSN}$ Nominal	194	200	206	mV
V_{CSN_HYS}	Sense threshold hysteresis			± 15		%
I_{CSN}	CSN Pin input current	$V_{IN}-V_{CSN}=50mV$		8		μA
Operating Current						
I_{SD}	Shutdown supply current			60	100	μA
I_{OFF}	Quiescent supply current with output off	No switching		0.16	0.3	mA
DIM Input						
V_{DIM}	Internal supply voltage	DIM floating		4.2		V
V_{DIM_H}	DIM input voltage High			0.3	0.35	V
V_{DIM_HYS}	DIM input voltage hysteresis		20	50	80	mV
F_{DIM_MIN}	Min.DIM Frequency			0.1		kHz
F_{DIM_MAX}	Max. DIM Frequency			20		kHz
R_{DIM}	DIM pull up resistor to Internal supply voltage			200		K Ω
I_{DIM_H}	DIM input leakage high	$V_{DIM}=5V$		2.8		μA
I_{DIM_L}	DIM input leakage low	$V_{DIM} = 0$		22		μA
Driver						
R_source	Gate driver source resistor	$V_{GS}=5.0V$		6		Ω
R_sink	Gate driver sink resistor			2		Ω
V_{OH}	Gate driver output-voltage high	$I_{DRV}=10mA$		4.8		V
V_{OL}	Gate driver output-voltage low	$I_{DRV}=10mA$			0.5	V
Output Switch						
T_{ON_MIN}	Minimum on time	Guarantee by Designer		100		nS
T_{OFF_MIN}	Minimum off time			100		nS
Thermal Shutdown						
T_{SD}	Thermal Shutdown Threshold	Temp Rising		150		$^{\circ}C$
T_{SD_HYS}	Thermal Shutdown hysteresis	Guarantee by Designer		20		$^{\circ}C$

Note 4: Typical parameters are measured at $25^{\circ}C$ and represent the parametric norm.

Note 5: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

SIMPLIFIED BLOCK DIAGRAM

OPERATION DESCRIPTION

The PT4121 in conjunction with current sense resistor (R_{CS}), the inductor ($L1$), and MOSFET forms a self oscillating continuous-mode buck converter.

When input voltage V_{IN} is first applied, the initial current in $L1$ and R_{CS} is zero and there is no output from the current sense circuit. Under this condition, the output of CS comparator is high. This turns on switch, causing current to flow from V_{IN} to ground, via R_{CS} , the LED(s), $L1$ and external MOSFET. The current rises at a rate determined by V_{IN} and $L1$ to produce a voltage ramp (V_{CSN}) across R_{CS} . When $(V_{IN} - V_{CSN}) > 230\text{mV}$, the output of CS comparator switches low and the switch turns off. The current flowing on the R_{CS} decreases at another rate. When $(V_{IN} - V_{CSN}) < 170\text{mV}$, the switch turns on again and the mean current on the LED is determined by $200\text{mV}/R_{CS}$.

The high-side current-sensing scheme and on-board current-setting circuitry minimize the number of external components while delivering LED current with $\pm 3\%$ accuracy, using a 1% sense resistor. The PT4121 allows dimming with a PWM signal at the DIM input. A logic level below 0.3V at DIM forces PT4121 to turn off the LED and the logic level at DIM must be at least 2.5V to turn on the full LED current. The frequency of PWM dimming ranges from 100Hz to 20 kHz.

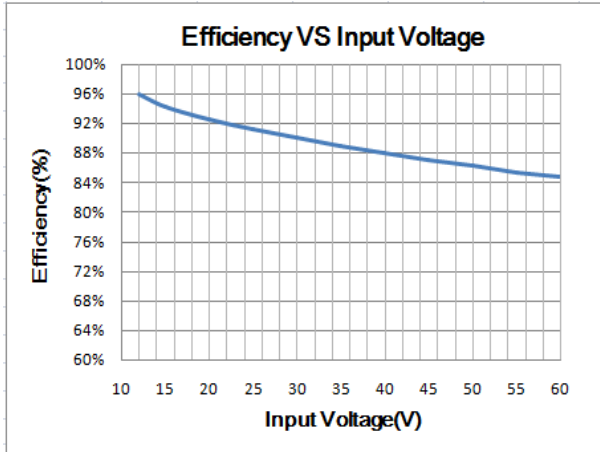
The DIM pin can be driven by an external DC voltage (V_{DIM}) to adjust the output current to a value below the nominal average value defined by R_{CS} . The DC voltage is valid from 0.5V to 2.5V. When the DC voltage is higher than 2.5V, the output current keeps constant.

Additionally, to ensure the reliability, the PT4121 is built with a thermal shutdown (TSD) protection. The TSD protects the IC from over temperature (150°C).

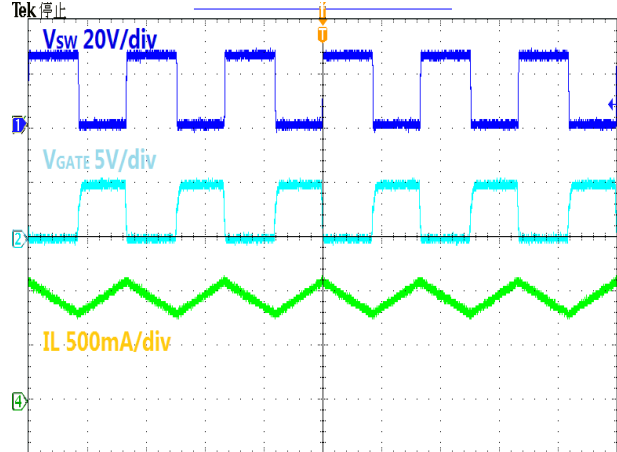
TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN}=24V, 3LEDs, I_{OUT}=1A, T_A=25^{\circ}C$, unless otherwise noted.

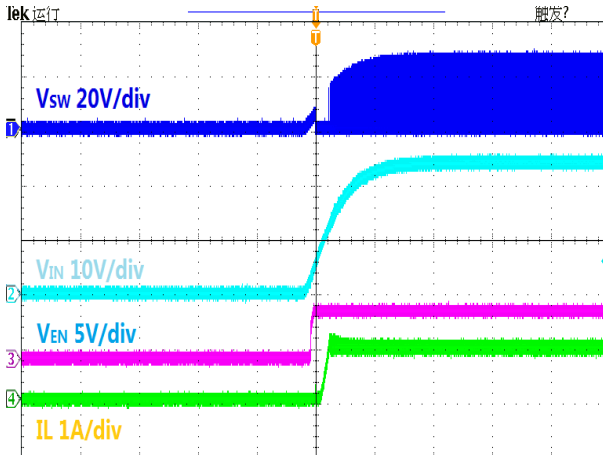
Efficiency



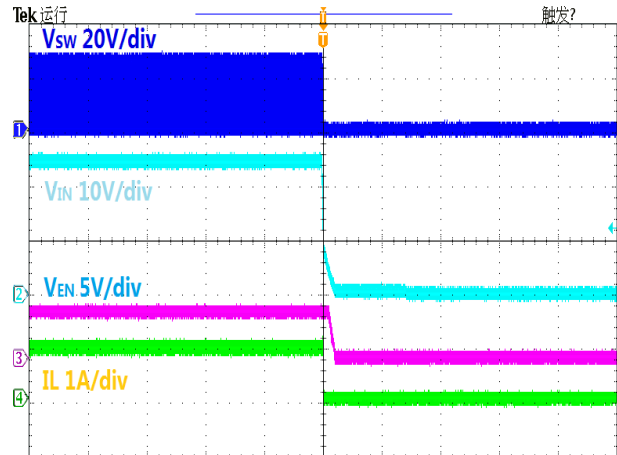
Steady State



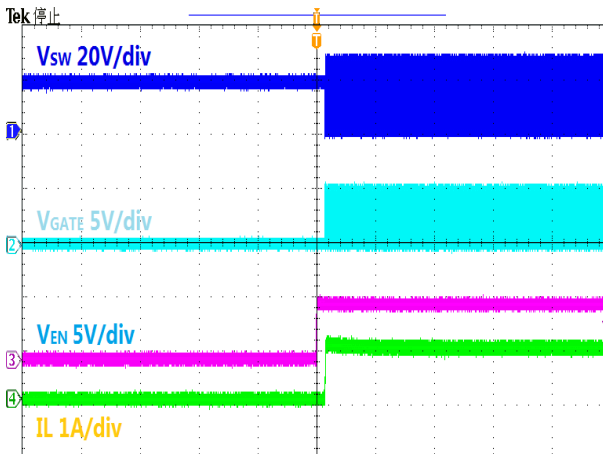
Input Power On



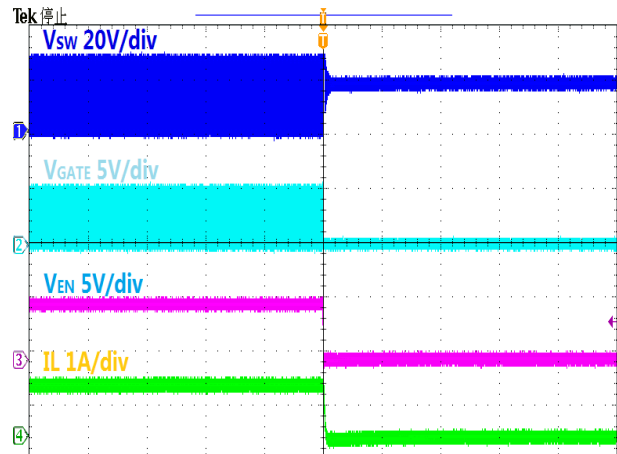
Input Power Off



EN Power On



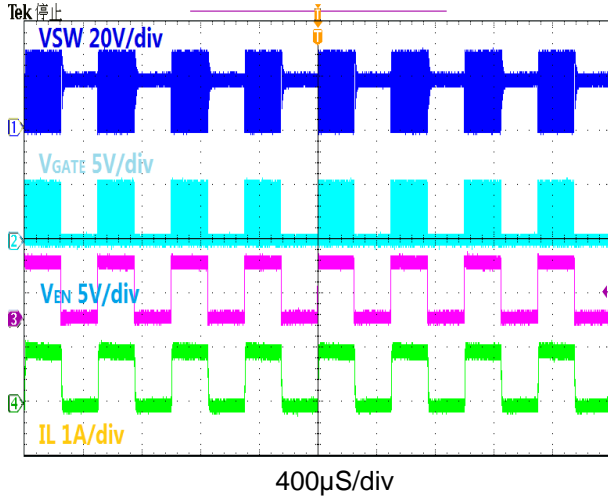
EN Power Off



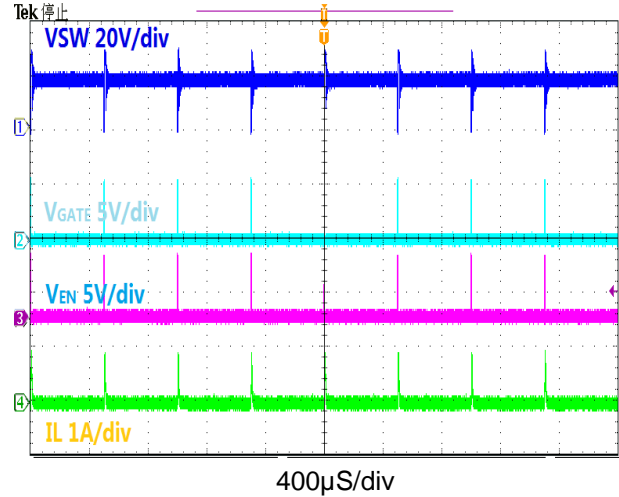
TYPICAL PERFORMANCE CHARACTERASTICS(continued)

$V_{IN}=24V, 3LEDs, I_{OUT}=1A, T_A=25^{\circ}C$, unless otherwise noted.

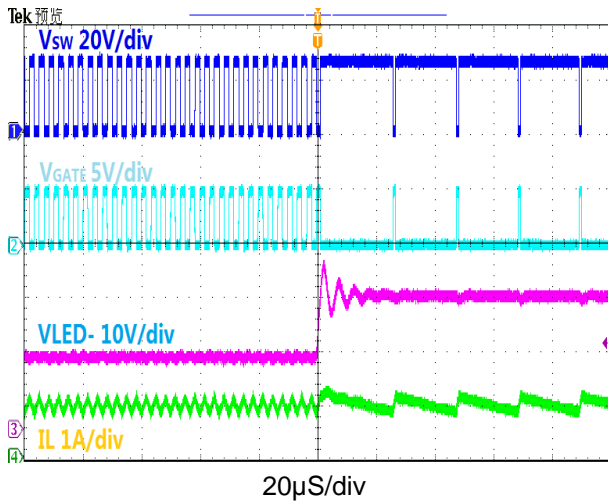
PWM Dimming
(2KHz,50%)



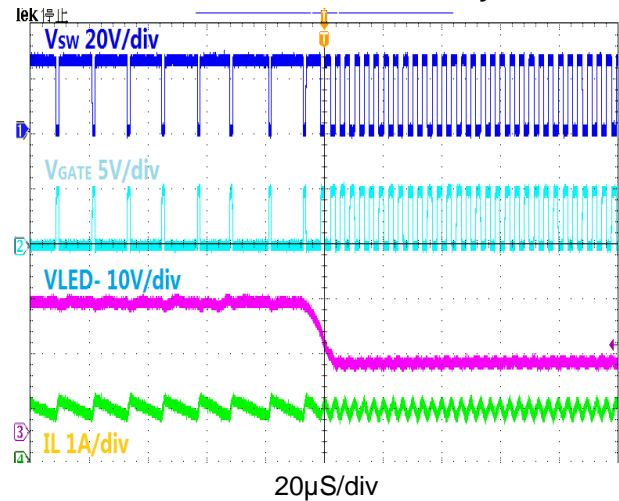
PWM Dimming
(2KHz,1%)



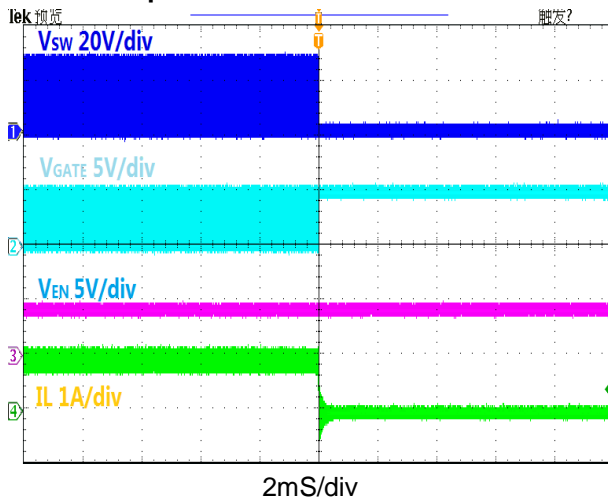
Short LED+ to LED- Protection



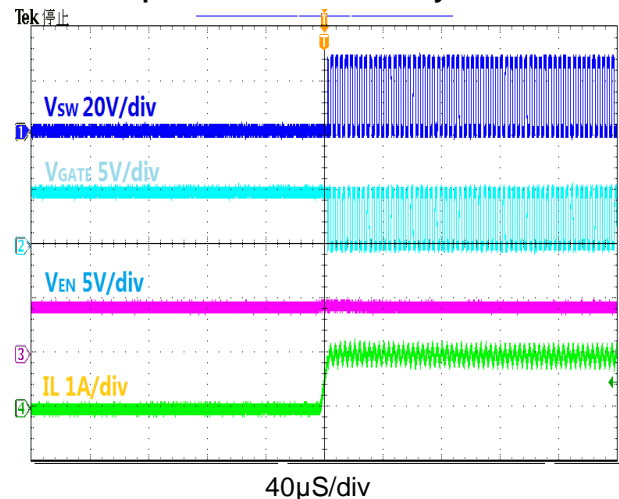
Short LED+ to LED- Recovery



Open LED Load Protection

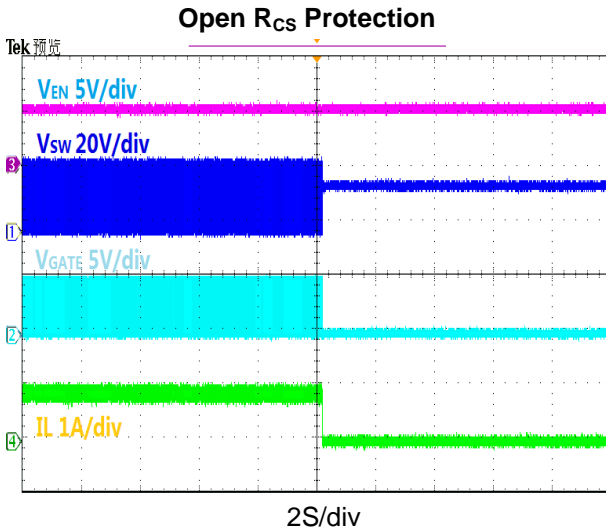


Open LED Load Recovery



TYPICAL PERFORMANCE CHARACTERISTICS(continued)

$V_{IN}=24V, 3LEDs, I_{OUT}=1A, T_A=25^{\circ}C$, unless otherwise noted.



APPLICATION NOTES

Setting nominal average output current with external resistor R_{CS}

The nominal average output current in the LED(s) is determined by the value of the external current sense resistor (R_{CS}) connected between VIN and CSN and is given by:

$$I_{OUT}=0.2/R_{CS}$$

This equation is valid when DIM pin is float or applied with a voltage higher than 2.5V (must be less than 5V). Actually, R_{CS} sets the maximum average current which can be adjusted to a less one by dimming.

Output current adjustment by external DC control voltage

The DIM pin can be driven by an external DC voltage (V_{DIM}), to adjust the output current to a value below the nominal average value defined by R_{CS} . The average output current is given by:

$$I_{OUT} = \frac{0.2 \times V_{DIM}}{2.5 \times R_{CS}} \quad (0.5V \leq V_{DIM} \leq 2.5V)$$

Note that 100% brightness setting corresponds to: $(2.5V \leq V_{DIM} \leq 5V)$

Output current adjustment by PWM control

A Pulse Width Modulated (PWM) signal with duty cycle PWM can be applied to the DIM pin, to adjust the output current to a value below the nominal average value set by resistor R_{CS} :

$$I_{OUT} = \frac{0.2 \times D}{R_{CS}} \quad (0 \leq D \leq 100\%, \quad 2.5V < V_{PULSE} < 5.0V)$$

$$I_{OUT} = \frac{0.2 \times D \times V_{PULSE}}{2.5 \times R_{CS}} \quad (0 \leq D \leq 100\%, \quad 0 < V_{PULSE} < 2.5V)$$

PWM dimming provides reduced brightness by modulating the LED's forward current between 0% and 100%. The LED brightness is controlled by adjusting the relative ratios of the on time to the off time. A 25% brightness level is achieved by turning the LED on at full current for 25% of one cycle. To ensure this

switching process between on and off state is invisible by human eyes, the switching frequency must be greater than 100 Hz. Above 100 Hz, the human eyes average the on and off times, seeing only an effective brightness that is proportional to the LED's on-time duty cycle. The advantage of PWM dimming is that the forward current is always constant, therefore the LED color does not vary with brightness as it does with analog dimming. Pulsing the current provides precise brightness control while preserving the color purity. The dimming frequency of PT4121 can be as high as 20 kHz.

Soft-start

An external capacitor from the DIM pin to ground will provide additional soft-start delay, by increasing the time taken for the voltage on this pin to rise to the turn-on threshold and by slowing down the rate of rise of the control voltage at the input of the comparator.

Input capacitor selection

A low ESR capacitor should be used for input decoupling, as the ESR of this capacitor appears in series with the supply source impedance and lowers overall efficiency. This capacitor has to supply the relatively high peak current to the coil and smooth the current ripple on the input supply. A minimum value of 10 μ F is acceptable if the DC input source is close to the device, but higher values will improve performance at lower input voltages, especially when the source impedance is high. The voltage rating should be greater than the input voltage. The input capacitor should be placed as close as possible to the IC. For maximum stability over temperature and voltage, capacitors with X7R, X5R, or better dielectric are recommended. Capacitors with Y5V dielectric are not suitable for decoupling in this application and should not be used.

Inductor selection

Lower value of inductance can result in a higher switching frequency, which causes a larger switching loss. Choose a switch frequency between 100kHz to 500kHz for most application. According to switching frequency, inductor value can be estimated as:

$$L = \frac{(1 - V_{OUT}/V_{IN}) \times V_{OUT}}{0.3 \times I_{LED} \times f_{SW}}$$

For higher efficiency, choose an inductor with a DC resistance as small as possible.

Output capacitor selection

For most applications, the output capacitor is not necessary. Peak to peak ripple current in the LED(s) can be reduced below 30% of the average current, if required, by adding a capacitor across the LED(s). A value of 2.2 μ F will meet most requirements. Proportionally lower ripple can be achieved with higher capacitor values. Note that the capacitor will not affect operating frequency or efficiency, but it will increase start-up delay and reduce the frequency of dimming, by reducing the rate of rise of LED voltage.

Thermal considerations

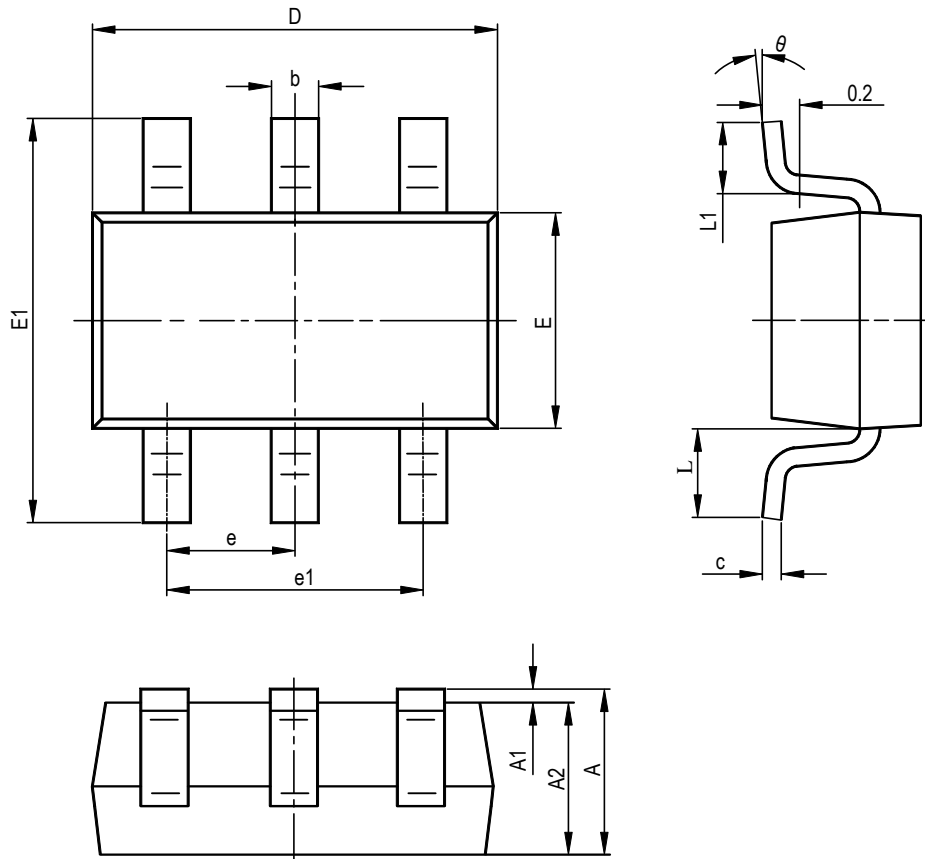
When the device operates at high ambient temperature, or when driving maximum load current, care must be taken to avoid exceeding the package power dissipation limits.

Layout considerations

Pay careful attention to the PCB layout and component placement. R_{CS} should be placed close to the VIN pin and CSN pin in order to minimize current sense error. The input loop including input capacitor, Schottky diode, and MOSFET which should be as short as possible.

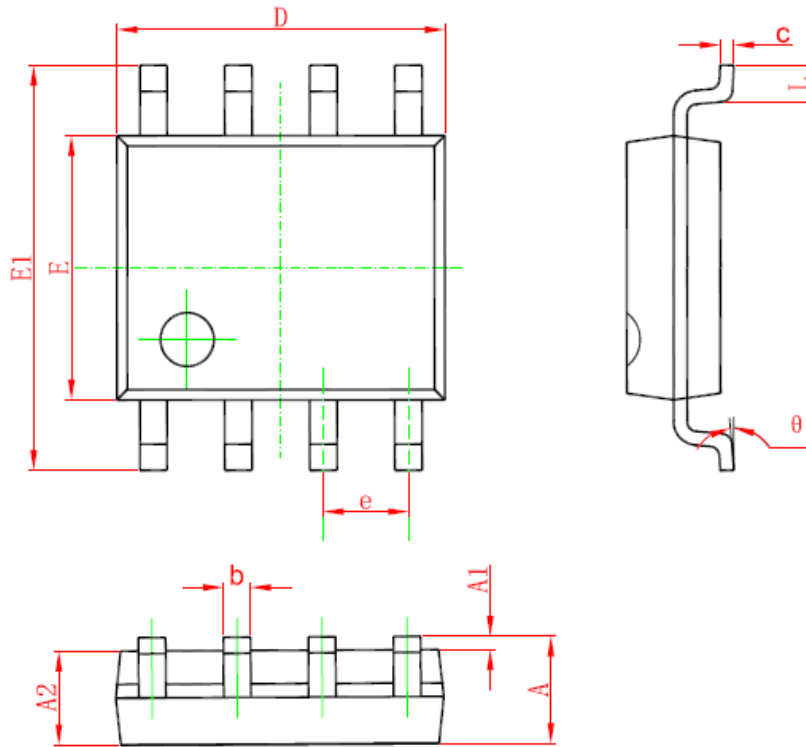
PACKAGE INFORMATION

SOT23-6 Package



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	-	1.450	-	0.057
A1	0.000	0.150	0.000	0.006
A2	0.900	1.300	0.035	0.051
b	0.300	0.500	0.012	0.020
c	0.080	0.220	0.003	0.009
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.600	2.950	0.102	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.600REF		0.024REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOP8 Package



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.250	1.650	0.049	0.065
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.05
θ	0°	8°	0°	8°

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